

# RZ/A2M Group

DRP Driver User's Manual

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#### 1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

#### 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
  In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.
- 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

The reserved addresses are provided for the possible future expansion of functions. Do not access
these addresses; the correct operation of LSI is not guaranteed if they are accessed.

#### 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator)
during a reset, ensure that the reset line is only released after full stabilization of the clock signal.
Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

#### 5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

# How to Use This Manual

# 1. Purpose and Target Readers

This manual is intended to provide the user with an understanding of the functions of the DRP driver software and how to utilize them. It is aimed at users designing application systems making use of the software. In order to use this manual, you will need a basic knowledge of programming languages and microprocessors.

Particular attention should be paid to the precautionary notes when using the software. These notes occur within the body of the text, and at the end of each section.

The revision history summarizes the locations of revisions and additions. It does not list all revisions. Refer to the text of the manual for details.

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# RZ/A2M Group DRP Driver User's Manual

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#### 1. Introduction

### 1.1 Summary

This manual describes the functions and usage of the DRP driver software, which controls the dynamic reconfigurable processor (DRP) of RZ/A2M Group microprocessors.

#### 1.2 Functions

DRP can be implemented a variety of functions corresponding to user's setting. In this manual the function implemented by DRP is referred to as "circuit" and the data representing the circuit information is referred to as "configuration data."\* The configuration data consists of binary data allocated in the memory.

As a device driver for the DRP, the DRP driver performs the following functions:

- Supplies a clock to the DRP and initializes the DRP driver.
- Stops supply of the clock to the DRP and terminates the DRP driver.
- Loads configuration data in the DRP.
- Erases configuration data loaded in the DRP. (Calls "unload" in this document.)
- Supplies a clock to and enables circuits written to the DRP.
- Stops supply of the clock to and disables circuits written to the DRP.
- Sets operation parameters of circuits written to the DRP and starts operation.
- Provides notification of operation completion by circuits written to the DRP.
- Gets the status (enabled or disabled, operating or not, etc.) of circuits written to the DRP.
- Gets information (version, etc.) from configuration data in the memory.
- Performs CRC checks on configuration data in the memory.

Note 1. Configuration data provided as DRP library. For details of DRP library, refer to RZ/A2M Group DRP Library User's Manual (R01US0367).

RZ/A2M Group 1. Introduction

### **1.3** Software Configuration

The software configuration of the DRP driver is shown below. The DRP driver comprises an interface portion and a core portion, and both are supplied as source code. The DRP driver supports FreeRTOS via an OS abstraction layer.

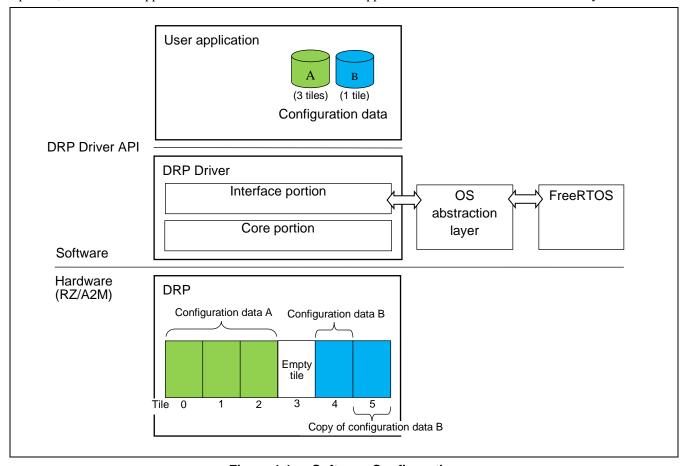


Figure 1.1 Software Configuration

- The DRP has six memory areas called "tiles" for loading configuration data.
- Configuration data is loaded in tile units.
- Each item of configuration data has its own tile count, represented as an integer value between 1 and 6. The tile count represents the number of tiles occupied by the configuration data.
- If the configuration data has a tile count of 3 or less, multiple copies can be loaded at the same time.
- In this manual the six tiles of the DRP are referred to as tile 0 to tile 5.
- In the figure above, one copy of configuration data A with tile count 3 is loaded in tile 0 through tile 2, and two copies of configuration data B with tile count 1 are loaded in tile 4 and tile 5, respectively.

RZ/A2M Group 2. Operation Conditions

# 2. Operation Conditions

The DRP driver operates under the conditions listed below.

**Table 2.1 Operation Conditions** 

Item	Description
Microprocessor	The DRP driver runs on the Cortex <sup>TM</sup> -A9 processor of RZ/A2M Group microprocessors.  The product numbers of compatible RZ/A2M Group microprocessors are as follows:*1
	R7S921051VCBG
	R7S921052VCBG
	R7S921053VCBG
Development environment	e <sup>2</sup> studio V7.8.0
	The following toolchain is compatible:
	GNU Arm Embedded Toolchain 6-2017-q2-update

Note 1. The DRP driver operates on RZ/A2M Group microprocessors equipped with a DRP function module. It will not operate on RZ/A2M Group microprocessors without a DRP function module.

RZ/A2M Group 3. File Structure

### 3. File Structure

Figure 3.1 shows the file structure of the DRP driver.

```
src
    renesas
         drivers
             drp
                  inc
                      r_dk2_if.h
                                             Header file of DRP Driver interface part
                  src
                       drp_iodefine.h
                                             IO definition file of DRP
                      r_dk2_core.c
                                             Source file of DRP Driver core part
                      r_dk2_core.h
                                             Header file of DRP Driver core part
                      r_dk2_if.c
                                             Source file of DRP Driver interface part
```

Figure 3.1 The File Structure of The DRP Driver

RZ/A2M Group 4. API Specifications

## 4. API Specifications

### 4.1 List of API Functions

Table 4.1 lists the API functions of the DRP driver.

**Table 4.1 API Functions of DRP Driver** 

API Function Name	Outline	Page
R_DK2_Initialize	Initializes DRP driver and initializes DRP.	7
R_DK2_Uninitialize	Stops DRP and terminates DRP driver.	8
R_DK2_Load	Loads configuration data in DRP.	9
R_DK2_Unload	Unloads configuration data from DRP.	15
R_DK2_Activate	Enables circuit in DRP.	16
R_DK2_Inactivate	Disables circuit in DRP.	17
R_DK2_Start	Starts operation of circuit in DRP.	18
R_DK2_GetStatus	Gets state of circuit in DRP.	20
R_DK2_GetInfo	Gets information from configuration data and checks CRC.	21
R_DK2_GetVersion	Gets DRP driver version information.	23

None of the API functions may be called from an interrupt context. For information on the reentrancy of API functions, refer to section 8, OS-Dependent Portion.

### 4.2 Error Codes

A return value of 0 or a positive number from a DRP driver API function indicates a normal end, and a negative return value indicates an abnormal end. When an abnormal end occurs, an error code is returned. Table 4.2 lists the error codes. For the specific conditions under which errors are generated, refer to the descriptions of the return values of the various API functions in section 5, API Reference.

**Table 4.2 Function Error Codes** 

Macro Name	Value	Description
R_DK2_SUCCESS	0	Normal end
R_DK2_ERR_ARG	-1	Argument error
R_DK2_ERR_FORMAT	-2	Format error
R_DK2_ERR_CRC	-3	CRC error
R_DK2_ERR_DEVICE	-4	Device error
R_DK2_ERR_BUSY	-5	Busy
R_DK2_ERR_INTERNAL	-6	Internal error
R_DK2_ERR_OVERWRITE	-7	Data overwrite error
R_DK2_ERR_OS	-8	OS error
R_DK2_ERR_STATUS	-9	Status error
R_DK2_ERR_TILE_PATTERN	-10	Tile pattern error
R_DK2_ERR_STOPPED	-11	Transfer stopped error

# 5. API Reference

### **5.1** How to Read the API Reference

API function name						
Function outline	Synchronous/asynchronous function					
Format	Shows the format used to call the API function. The header file designated by #include "header file" is the standard header file required to run the API function. Do not fail to include this header file. The designations I and O indicate that the corresponding argument is input data or output data, respectively. The designation IO indicates input/output data.					
Return values	Lists the return values of the API function. Comments following the colon (:) after the return value provide a description of the return value (such as return conditions).					
Description	Describes the specifications of the API function.					
Note Any precautionary notes appear here.						

# **5.2** R\_DK2\_Initialize

R DK2	Initialize		DRP driver API			
	RP driver and initializes DRP		Synchronous function			
Format	#include "r_dk2_if.h"					
	int32_t R_DK2_Initialize(vo	oid);				
Return valu	es R_DK2_SUCCESS	: 1	Normal end.			
	R_DK2_ERR_DEVICE	: ,	Abnormal end.			
		-	This error is generated when initialization of the DRP fails.			
	R_DK2_ERR_OS	: /	Abnormal end.			
		-	This error is generated when securing of an OS resource			
		1	fails.			
	R_DK2_ERR_STATUS	: .	Abnormal end.			
			This error is generated when the DRP driver has already			
			been initialized.			
Description			variables and secures OS resources, putting the DRP driver			
	the DRP from low-power mode, starts supply of the clock,					
	and initializes the hardware	).				
Note	If the error R_DK2_ERR_DEVICE occurs, check the device used. The DRP driver is compate					
			rs equipped with a DRP function module. For details of the			
			fer to section 2, Operation Conditions. If the value			
	R_DK2_ERR_OS is returned, reevaluate the OS settings.					

# **5.3** R\_DK2\_Uninitialize

R DK2	Uninitialize		DRP driver API	
	and terminates DRP driver		Synchronous function	
Format	#include "r_dk2_if.h"			
	int32_t R_DK2_Uninitalize(vo	oid);		
Return value	es R_DK2_SUCCESS	:	Normal end.	
	R_DK2_ERR_OS	:	Abnormal end.	
			This error is generated when releasing of an OS resource	
			fails.	
	R_DK2_ERR_STATUS	:	Abnormal end.	
			This error is generated when the DRP driver has already	
			been terminated.	
Description This API function stops supply of the clock to the DRP and transitions the DRP to low mode. It performs a forced stop if the DRP is operating. Also, it releases OS resource			·	
transitions the DRP driver to the uninitialized state. After this API function runs, the				
			the next time the R_DK2_Initialize function is called.	
Note This API function performs a forced stop if the DRP is operating. Note			ed stop if the DRP is operating. Note that in this case the	
	callback function set by the F	2_Load function may not be called.		
	If the value R_DK2_ERR_OS	is re	eturned, reevaluate the OS settings.	

### **5.4** R\_DK2\_Load

### R DK2 Load

DRP driver API

Loads configuration data in DRP

Synchronous/asynchronous function

**Format** 

#include "r\_dk2\_if.h"

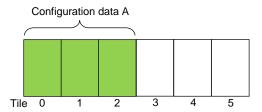
int32\_t R\_DK2\_Load(const void \*const pconfig, const uint8\_t top\_tiles, const uint32\_t tile\_pattern, const load\_comp\_t pload, const process\_comp\_t pprocess, uint8\_t \*const paid):

pconfig	ı	Specifies the address of the configuration data to be
		loaded. The configuration data must be aligned with a
		32-byte boundary. Also, the configuration data must
		exist in physical memory.

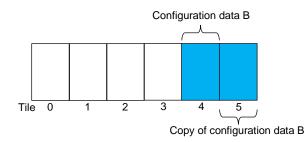
top\_tiles I

Specifies the start tile position where the configuration data is allocated using macros R\_DK2\_TILE\_0 to R\_DK2\_TILE\_5, which represent the six tiles of the DRP, tile 0 to tile 5. When loading multiple configuration data items, obtain the logical sum (logical OR) of each bit of the above macros.

For example, to allocate configuration data A with tile count 3 to tile 0 through tile 2, specify "R\_DK2\_TILE0".



For example, to allocate two copies of configuration data B with tile count 1 to tile 4 and tile 5, respectively, specify "R\_DK2\_TILE\_4 | R\_DK2\_TILE\_5".



tile\_pattern

Specifies the tile pattern. For setting values, refer to 5.4.1, Tile Patterns. Once the tile pattern has been set, use the same tile pattern setting until the configuration data for all tiles has been unloaded using the R\_DK2\_Unload function. When an attempt is made to change the tile pattern when the DRP is in a state in which configuration data has already been loaded, the API function returns a value of R\_DK2\_ERR\_TILE\_PATTERN.

pload	Specifies the address of the callback function used to provide notification when loading of configuration data completes. For detailed specifications of the callback function specified by the argument pload, refer to 5.4.2, Load Completion Callback Function. When a value other than NULL is specified for this argument, loading of configuration data can be halted by the R_DK2_Unload function. When NULL is specified for this argument, the R_DK2_Unload function cannot halt loading of configuration data, and this API function finishes only when loading is complete.
pprocess	Specifies the address of the callback function used to provide notification when the processing started using the R_DK2_Start function completes. For detailed specifications of the callback function specified by the argument pprocess, refer to 5.8.1, Processing Completion Callback Function. This notification does not occur if NULL is specified.
paid	Specifies the address of the six-element array used to perform notification of the ID for identifying the loaded configuration data. Index 0 to index 5 of the array represent the six tiles of the DRP, tile 0 to tile 5, and the array elements represent the IDs of the configuration data items loaded in the corresponding tiles. If a configuration data item occupies multiple tiles, the same ID is stored in all the array elements representing the corresponding tiles. Each ID is a unique positive number corresponding to a single circuit, and a value of 0 means that no configuration data is loaded. If multiple copies of a configuration data item are loaded, each copy is assigned a different ID. When notification of IDs is made by this argument, the notification covers the IDs for all six tiles following execution of the R_DK2_Load function, including all configuration data that has been written to that point. This notification does not occur if NULL is specified.

For example, if configuration data A with tile count 3 is allocated to tile 0 through tile 2, and two copies of configuration data B with tile count 1 are allocated to tile 4 and tile 5, respectively, the contents of the array are as shown below.

Index	Description				
0	Circuit ID of configuration data A circuit				
	information				
1	Same as index 0				
2	Same as index 0				
3	0				
4	Circuit ID of configuration data B circuit				
	information				
5	Circuit ID of configuration data B circuit				
	information (different from index 4)				

Return values R_DK2_SUCCESS	:	Normal end.
R_DK2_ERR_ARG	:	Abnormal end.
		This error is generated in the following cases:
		<ul> <li>NULL is specified for argument pconfig.</li> </ul>
		<ul> <li>A value that is not aligned with a 32-byte boundary</li> </ul>
		is specified for argument pconfig.
		<ul> <li>The argument top_tiles is not in the format of the</li> </ul>
		logical sum (logical OR) of each bit of
		R_DK2_TILE_0 to R_DK2_TILE_5.
		<ul> <li>A macro other than those listed in Table 5.1 is</li> </ul>
		specified for argument tile_pattern.
R_DK2_ERR_FORMAT	:	Abnormal end.
		This error is generated when a format error is detected in the configuration data.
R_DK2_ERR_DEVICE	:	Abnormal end.
		This error is generated when NULL is specified for
		argument pload and a transfer error occurs during
		loading of configuration data.
R_DK2_ERR_BUSY	:	Abnormal end.
		This error is generated when a value other than NULL is specified for argument pload and, during loading of configuration data, an attempt is made to load other
D DK2 EDD OVEDWDITE		configuration data.
R_DK2_ERR_OVERWRITE	•	Abnormal end.
		This error is generated when other configuration data has already been written to the load position of the
R_DK2_ERR_OS		specified configuration data.  Abnormal end.
K_DKZ_EKK_OS	•	This error is generated when exclusive control by the
		OS fails.
R_DK2_ERR_STATUS	:	Abnormal end.
		This error is generated when the DRP driver has not
		been initialized.
R_DK2_ERR_TILE_PATTERI	N:	Abnormal end.
		This error is generated in the following cases:
		The tile pattern is changed when the DRP is in a
		state in which configuration data has already been loaded.
		<ul> <li>The tile position or tile count in the configuration data do not match the tile pattern.</li> </ul>

#### Description

When a value other than NULL is specified for the argument pload, this API function starts loading the configuration data in the DRP and notifies when loading completes by means of a callback function. At this time, other configuration data cannot be loaded until loading completes. In such cases the value R\_DK2\_ERR\_BUSY is returned, and this API function fails. Also, if a value other than NULL is specified for the argument pload, it is possible to halt loading of configuration data with the R\_DK2\_Unload function.

When NULL is specified for the argument pload, loading of the configuration data continues until completion when this API function is run. In this case, loading of configuration data cannot be halted by the R\_DK2\_Unload function.

It is also possible for this API function to load configuration data to multiple tile positions. For details of the callback function specified by the argument pload, refer to 5.4.2, Load Completion Callback Function, and for details of the callback function specified by the argument pprocess, refer to 5.8.1, Processing Completion Callback Function.

This API function uses OS functionality to provide exclusive control so that multiple DRP driver API functions are not executed at the same time. If a failure occurs because resource acquisition times out during exclusive control, the value R\_DK2\_ERR\_OS is returned and the API function fails.

### Note

If the value R\_DK2\_ERR\_FORMAT is returned, check to make sure the address specified for argument pconfig is the correct address of the configuration data.

A return value of R\_DK2\_ERR\_DEVICE indicates that an error occurred during transfer of the configuration data. Reevaluate the memory settings, etc., for the allocation of the configuration data.

If the configuration data specified by the argument pconfig exists in the Cortex-A9 cache and the data in the physical memory does not match the configuration data, proper loading will not be possible. It may be necessary to clear the cache before calling this API function or to allocate the configuration data to a non-cached area.

### **5.4.1** Tile Patterns

The tile count and tile position combinations used when loading configuration data in the DRP are limited to the 11 patterns listed in Table 5.1. Set the appropriate macro value below in the argument tile\_pattern of the R\_DK2\_Load function to match the combination to be used.

**Table 5.1 Tile Patterns** 

Tile Pattern	Macro Setting of Argument tile_pattern of R_DK2_Load Function
1 1 1 1 1	R_DK2_TILE_PATTERN_1_1_1_1_1
2 1 1 1 1	R_DK2_TILE_PATTERN_2_1_1_1
2 2 1 1	R_DK2_TILE_PATTERN_2_2_1_1
2 2 2	R_DK2_TILE_PATTERN_2_2_2
3 1 1 1	R_DK2_TILE_PATTERN_3_1_1_1
3 2 1	R_DK2_TILE_PATTERN_3_2_1
3 3	R_DK2_TILE_PATTERN_3_3
4 1 1	R_DK2_TILE_PATTERN_4_1_1
4 2	R_DK2_TILE_PATTERN_4_2
5 1	R_DK2_TILE_PATTERN_5_1
6	R_DK2_TILE_PATTERN_6

n : Configuration data with tile count n

# 5.4.2 Load Completion Callback Function

Load co	mpletion call	back fund	tion	Callback function
	of loading of configura			Synchronous function
Format	#include "r_dk2_if.h	ו"		
	void load_comp(uir	t8_t id, int32_t	result);	
	Note: This function	can be given ar	ny name.	
	id	I	ID of circuit that has finished loading	
	result		R_DK2_SUCCESS:	
			Indicates that loading has completed su	uccessfully.
			R_DK2_ERR_DEVICE:	·
			Indicates that a transfer error occurred	while loading
			configuration data.	_
			R_DK2_ERR_STOPPED:	
			Indicates that while loading configuration	on data the transfer
			was stopped by calling the R_DK2_Unl	oad function.
Return value	s None			
Description	This is the callback	function specifi	ed by the argument pload of the R_DK2	_Load function. It
•	provides notification	n when the load	ing of configuration data finishes. When	multiple
	configuration data items are loaded, this callback function is called once for each item loaded.			
	This function is exe	cuted in the inte	errupt context. This function must not cal	ll any DRP driver
	function.		·	·
Note	If the value of the a etc., for the allocation	•	is R_DK2_ERR_DEVICE, reevaluate the uration data.	e memory settings,

# **5.5** R\_DK2\_Unload

R_DK2	Unload		DRP driver API
	figuration data from DRP		Synchronous function
Format	#include "r_dk2_if.h"		
	int32_t R_DK2_Unload(cons	st uint8	3_t id, uint8_t *const paid);
	id	I	Specifies the ID of the circuit to be unloaded. To unload multiple circuits, specify the logical sum (logical OR) of each bit of the IDs of each of the circuits. Specifying 0 causes all loaded circuits to be unloaded.
	paid	0	To obtain notification of the DRP load status following execution of this function, specify the address of a six-element array prepared by the user. Index 0 to index 5 of the array represent the six tiles of the DRP, tile 0 to tile 5, and the array elements represent the IDs of the configuration data items loaded in the corresponding tiles. If a configuration data item occupies multiple tiles, the same ID is stored in all the array elements representing the corresponding tiles. This ID is a unique positive number corresponding to a single circuit, and a value of 0 means that no configuration data is loaded. If multiple copies of the same configuration data item are loaded, each copy is assigned a different ID. When notification of IDs is made by this argument, the notification covers the IDs for all six tiles following execution of the R_DK2_Unload function, including all configuration data that has been written to that point. This notification does not occur if NULL is specified.
Return value	s R_DK2_SUCCESS	:	Normal end.
	R_DK2_ERR_ARG	:	Abnormal end.
			This error is generated when the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS	:	Abnormal end.  This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	:	Abnormal end. This error is generated in the following cases: The DRP driver has not been initialized.
Description	circuit is unloaded, configura API function will forcibly unle operating.  If this API function is called the callback function specific this point, the value of the called function specified by the ppi the value of the callback function specified by the ppi the value of the callback function also possible to unload This API function uses OS f API functions are not execuracquisition times out during	ation do ad the during ed by the allback during rocess action's multiple unction ted at	uit corresponding to the specified ID from the DRP. After the lata can once again be loaded in the same tile position. This is circuit even if it is in the process of being loaded or if it is loading of configuration data, loading of data is canceled and the pload argument of the R_DK2_Load function is called. At a function's result argument is R_DK2_ERR_STOPPED. Also, circuit operation, the circuit stops operating and the callback argument of the R_DK2_Load function is called. At this point, is result argument is R_DK2_ERR_STOPPED. The circuits or all currently loaded circuits. In ality to provide exclusive control so that multiple DRP driver the same time. If a failure occurs because resource sive control, the value R_DK2_ERR_OS is returned and the
Nata	API function fails.		
Note	None.		

# **5.6** R\_DK2\_Activate

R DK2	Activate	DRP driver API
Enables circ		Synchronous function
Format	#include "r_dk2_if.h" int32_t R_DK2_Activate(co	onst uint8_t id, const uint32_t freq);
	id	I Specifies the ID of the circuit to be enabled. To enable multiple circuits, specify the logical sum (logical OR) of each bit of the IDs of each of the circuits. Specifying 0 causes all loaded circuits to be enabled.
	freq	I Specifies 0.
Return value	s R_DK2_SUCCESS	: Normal end.
	R_DK2_ERR_ARG	<ul> <li>Abnormal end.         This error is generated when the value of the argument id does not correspond to a circuit currently loaded in the DRP.     </li> </ul>
	R_DK2_ERR_OS	: Abnormal end.  This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	<ul> <li>: Abnormal end. This error is generated in the following cases: <ul> <li>The DRP driver has not been initialized.</li> </ul> </li> <li>• The circuit specified by the argument id is not in the loaded state.</li> <li>• 0 was specified for the argument id and no circuit is currently in the loaded state.</li> </ul>
		(For information on circuit states, refer to 6.2, State Transitions of Individual Circuits.)
Description	corresponding tile, and puts It is also possible to activat as the argument id in order affected. (For information of This API function uses OS API functions are not execu-	a circuit currently loaded in the DRP, supplies a clock to the stee circuit into a usable state.  e multiple circuits or all currently loaded circuits. When 0 is specified to enable all circuits, only circuits currently in the loaded state are on circuit states, refer to 6.2, State Transitions of Individual Circuits.) functionality to provide exclusive control so that multiple DRP driver uted at the same time. If a failure occurs because resource g exclusive control, the value R_DK2_ERR_OS is returned and the
Note	None.	

# **5.7** R\_DK2\_Inactivate

R DK2	Inactivate	DRP driver API
Disables circ		Synchronous function
Format	#include "r_dk2_if.h" int32_t R_DK2_Inactivate(con	
	id	Specifies the ID of the circuit to be disabled. To disable multiple circuits, specify the logical sum (logical OR) of each bit of the IDs of each of the circuits. Specifying 0 causes all loaded circuits to be disabled.
Return value	es R_DK2_SUCCESS	: Normal end.
	R_DK2_ERR_ARG	: Abnormal end.
		This error is generated when the value of the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS	: Abnormal end. This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	<ul> <li>Abnormal end. This error is generated in the following cases: <ul> <li>The DRP driver has not been initialized.</li> <li>The circuit specified by the argument id is not in the activated or started state.</li> <li>0 was specified for the argument id and no circuit is currently in the activated or started state.</li> </ul> </li> <li>(For information on circuit states, refer to 6.2, State)</li> </ul>
Description	corresponding tile, and puts the lt is also possible to disable mas the argument id in order to started state are affected.  This API function uses OS fundament in the state are affected.	Transitions of Individual Circuits.) ircuit currently loaded in the DRP, stops supply of the clock to the ne circuit into the low-power state. inultiple circuits or all currently loaded circuits. When 0 is specified disable all circuits, only circuits currently in the activated or inctionality to provide exclusive control so that multiple DRP driver d at the same time. If a failure occurs because resource inclusive control, the value R_DK2_ERR_OS is returned and the
Note	None	

# 5.8 R\_DK2\_Start

R_DK2_	Start	DRP driver API
	tion of circuit in DRP	Asynchronous function
Format	#include "r_dk2_if.h"	
	int32_t R_DK2_Start(const	uint8_t id, const void *const pparam, const uint32_t size);
	id	I Specifies the ID of the circuit that will start operating.
	pparam	I Specifies the area for storing parameters for circuit operation. The area where parameters are stored must exist in physical memory. The parameter storage area for each circuit is read independently, so it is not possible for one area to be shared by multiple circuits.  The parameter specifications are different for each
		configuration data. For the parameter specifications of each configuration data, refer to RZ/A2M Group DRP Library User's Manual (R01US0367).
	size	I Specifies the size of the parameter area specified by the argument pparam.
Return value	es R_DK2_SUCCESS	: Normal end.
	R_DK2_ERR_ARG	: Abnormal end.
		This error is generated in the following cases:
		<ul> <li>The value of the argument id does not correspond to a circuit currently loaded in the DRP.</li> </ul>
		<ul> <li>NULL is specified for the argument pparam.</li> </ul>
		<ul> <li>0 is specified for the argument size.</li> </ul>
	R_DK2_ERR_OS	: Abnormal end.
		This error is generated when exclusive control by the OS fails.
	R_DK2_ERR_STATUS	: Abnormal end.
		This error is generated in the following cases:
		<ul> <li>The DRP driver has not been initialized.</li> </ul>
		<ul> <li>The circuit specified by the argument id is not in the activated state.</li> </ul>
		(For information on circuit states, refer to 6.2, State Transitions of Individual Circuits.)
Description	of processing is provided by argument pprocess of the R callback function, refer to 5.	ration of a circuit loaded in the DRP. Notification of the completion the processing completion callback function specified by the LDK2_Load function. For details of the processing completion 8.1, Processing Completion Callback Function.
	API functions are not execu	functionality to provide exclusive control so that multiple DRP driver ted at the same time. If a failure occurs because resource exclusive control, the value R_DK2_ERR_OS is returned and the
Note	the circuit's I/O data exists i in physical memory do not r	re the area set by the argument pparam for storing parameters or in the cache of the Cortex-A9, and the parameters or circuit I/O data match, the circuit will not operate properly. It may be necessary to ing this API function or to allocate the parameters and circuit I/O data

# **5.8.1** Processing Completion Callback Function

Process	sing completion	n callback function	Callback function				
	of processing started by		Synchronous function				
Format	#include "r_dk2_if.h"						
	void process_comp(u	nt8_t id, int32_t result);					
	Note: This function can be given any name.						
	id	I ID of circuit whose p	rocessing has finished				
	result	I R_DK2_SUCCESS:					
		Indicates that proces	ssing has completed successfully.				
		R_DK2_ERR_DEVI	CE:				
		Indicates that a trans	sfer error occurred while transferring				
		parameters set by th	e R_DK2_Start function or while				
		transferring circuit I/0	O data.				
		R_DK2_ERR_STOP	PPED:				
		Indicates that while t	ransferring parameters set by the				
		R_DK2_Start function	n or while transferring circuit I/O data				
		the transfer was stop	pped by calling the R_DK2_Unload				
		function or the R_Dk	<2_Inactivate function.				
Return value	es None						
Description	This is the callback fu	nction specified by the argument p	process of the R_DK2_Load function. It				
-	provides notification when the processing started by R_DK2_Start function finishes. The						
	number of times this	callback function is called is the sai	me as the number of times the				
	R_DK2_Start function	is called, unless an event such as	a forced unload by the R_DK2_Unload				
	function occurs.						
	This function is executed in the interrupt context. This function must not call any DRP driver						
	function.						
Note	If the value of the arg	ument result is R_DK2_ERR_DEV	ICE, reevaluate the memory settings,				
	etc., for the allocation	of the parameters set by the R_DI	K2_Start function or circuit I/O data.				

# **5.9** R\_DK2\_GetStatus

R DK2	GetStatus	DRP driver API
· <del></del>	f circuit in DRP	Synchronous function
Format	#include "r_dk2_if.h"	·
	int32_t R_DK2_GetStatus(const	uint8_t id);
	id I	Specifies the ID of the circuit to be whose state is to be acquired.
Return value	es R_DK2_STATUS_LOADED :	Normal end.
		Indicates that the specified circuit is in the loaded state.
	R_DK2_STATUS_ACTICATE:	Normal end.
	D	Indicates that the specified circuit is in the activated state
	R_DK2_STATUS_STARTED :	Normal end.
		Indicates that the specified circuit is in the started state.
	R_DK2_STATUS_LOADING :	Normal end.
		Indicates that the specified circuit is in the loading state.
	R_DK2_ERR_ARG :	Abnormal end.
		This error is generated when the value of the argument id does not correspond to a circuit currently loaded in the DRP.
	R_DK2_ERR_OS :	Abnormal end.
		This error is generated when exclusive control by the OS fails.
Description	means that the function complet the circuit. A negative return value represents an error code. For informations of Individual Circuits This API function uses OS functions.	of a circuit currently loaded in the DRP. A positive return value ed successfully, and the value returned indicates the state of the means that the function failed, and the value returned formation on circuit states in the DRP, refer to 6.2, State in the provide exclusive control so that multiple DRP driver at the same time. If a failure occurs because resource usive control, the value R_DK2_ERR_OS is returned and the
Note	None	

### 5.10 R DK2 GetInfo

	GetInfo					DRP driver A	
	nation from configuration data and checks CRC.				Synchronous functi		
ormat	<pre>#include "r_dk2_if.h" int32_t R_DK2_GetInfo(const void *const pconfig, config_info_t *const pinfo, co crc_check);</pre>					fo_t *const pinfo, const bool	
	pconfig I Specifies the address of the configuration data						
	Footing		information is obtained. The configuration data must be aligned with a 32-byte boundary.				
	pinfo	info O Specifies the address of the structure configvariable. This API function stores the following from the configuration data in the members of the structure configuration stores that the members of the structure configuration stores are configuration.					
			Member Name	Туре	)	Description	
			type	uint8	<u>_t</u>	This area is reserved. The data stored here consists of zeros.	
			pname	char	*	Stores a pointer to a character string of up to 31 bytes representing the circuit name.	
			ver	uint3	2_t	Stores the version of the configuration data.*1	
			cid	uint3	2_t	Stores a unique ID representing the circuit stored in the configuration data.	
			Note 1. The	e stora	ge foi	rmat of the member ver is as	
			Bit Position	n D	escri	iption	
			0 to 7	S	tores	the build number.	
			8 to 15	S	tores	the minor version.	
			16 to 23	S	tores	the major version.	
			24 to 31			rea is reserved. The data stored onsists of zeros.	
			For example	e, a ver	value	e of 0x00010201 represents version	
	crc_check	I	•	n the c		e whether or not a CRC check is uration data when getting	
eturn value	s R_DK2_SUCCESS	:	Normal end	•			
	R_DK2_ERR_ARG	:	Abnormal e	nd.			
			This error is or pinfo has			when pconfig has a value of NULL NULL.	
	R_DK2_ERR_FORMAT	:	Abnormal end.  This error is generated when a format error is detected in the configuration data.				
	R_DK2_ERR_CRC	:	Abnormal end.				
						when the argument crc_check is s is detected in the configuration	

data.

Description	This API function gets information from the configuration data at the address specified by the argument pconfig. It writes the information obtained from the configuration data to the address specified by the argument pinfo.  This API function also performs a CRC check on the configuration data. If the CRC check fails, the value R_DK2_ERR_CRC is returned and an abnormal end occurs.
Note	If a value of R_DK2_ERR_FORMAT is returned, confirm that the address specified by the argument pconfig is the correct address of the configuration data.

### **5.11** R\_DK2\_GetVersion

## R DK2 GetVersion

DRP driver API

Gets DRP driver version information

Synchronous function

Format

#include "r\_dk2\_if.h"

uint32\_t R\_DK2\_GetVersion(void);

Return values DRP driver version

information

The storage format is as shown below.

Bit Position	Description
0 to 7	Stores the build number.
8 to 15	Stores the minor version.
16 to 23	Stores the major version.
24 to 31	This area is reserved. The data stored here consists of zeros.

For example, a return value of 0x00010201 represents version 1.21.

Description	This API function gets the version number of the DRP driver.
Note	None

RZ/A2M Group 6. State Transitions

### 6. State Transitions

### **6.1** State Transitions of the DRP Driver Overall

Figure 6.1 shows state transitions and the clock supply status of the DRP driver overall.

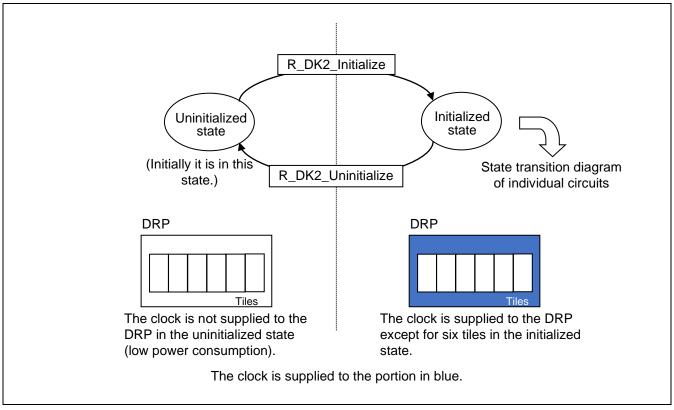


Figure 6.1 State Transitions and Clock Supply Status of DRP Driver Overall

RZ/A2M Group 6. State Transitions

### **6.2** State Transitions of Individual Circuits

Figure 6.2 shows state transitions and the clock supply status of individual circuits.

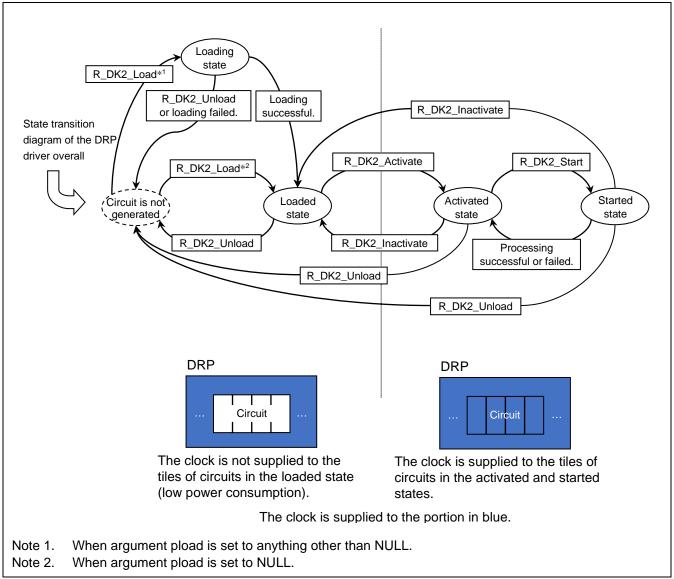


Figure 6.2 State Transitions and Clock Supply Status of Individual Circuits

RZ/A2M Group 7. Control Flowchart

### 7. Control Flowchart

Figure 7.1 is a flowchart of a DRP driver usage example.

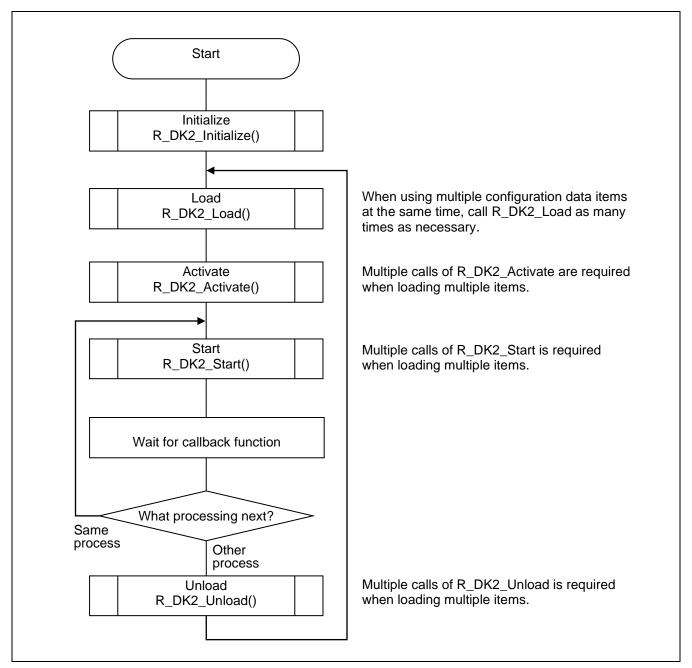


Figure 7.1 DRP Driver Usage Example

### 8. OS-Dependent Portion

### **8.1** Support for reentrancy of API functions

The OS-dependent portion of the DRP driver is separated from the rest as an OS abstraction layer. The DRP driver supports FreeRTOS via this OS abstraction layer.

The functionality provided by the DRP driver by means of the OS-dependent portion is support for reentrancy of API functions. Exclusive control employing the mutual exclusion (Mutex) capability of FreeRTOS is used to enable reentrancy for some of the API functions, as indicated in Table 8.1.

To implement reentrancy the DRP driver uses a single Mutex to provide exclusive control. When an API function supporting reentrancy is running and another API function supporting reentrancy is called, the second API function waits until the first API function finishes.

It is possible to use the macro MUTEX\_WAIT defined in r\_dk2\_if.c to set the timeout duration during exclusive control. To specify the timeout duration, assign an integer between 0 and 0xFFFFFFFF to the macro MUTEX\_WAIT. The setting value represents the timeout duration in millisecond units. A value of 0 means no wait. The default timeout duration setting is 100 milliseconds.

**Table 8.1 Reentrancy Support of DRP Driver API Functions** 

API Function Name	Reentrancy Support	
R_DK2_Initialize	Reentrancy not supported	7
R_DK2_Uninitialize	Reentrancy not supported	8
R_DK2_Load	Reentrancy supported	9
R_DK2_Unload	Reentrancy supported	15
R_DK2_Activate	Reentrancy supported	16
R_DK2_Inactivate	Reentrancy supported	17
R_DK2_Start	Reentrancy supported	18
R_DK2_GetStatus	Reentrancy supported	20
R_DK2_GetInfo	Reentrancy not supported	21
R_DK2_GetVersion	Reentrancy not supported	23

### **8.2** DRP Driver Interrupt Priority

The DRP Driver interrupt priority levels are defined in the macros in Table 8.2.

FreeRTOS API functions cannot be called in interrupts that have a higher priority than the value of configMAX\_API\_CALL\_INTERRUPT\_PRIORITY defined in FreeRTOSConfig.h. Be careful when using FreeRTOS service calls to wait for DRP to complete.

Table 8.2 DRP Driver Interrupt Priority Macro Definition (r\_dk2\_if.h)

Macro Name	Value	Description
DRP_INTERRUPT_PRIORITY	26	DRP Driver interrupt priority level

RZ/A2M Group 9. Memory footprint

# 9. Memory footprint

**Table 9.1** lists the approximate sizes of memory used by the DRP Driver.

**Table 9.1** Memory Resources

Section name	Size (approx.)
Code	12k bytes
Constant Data	0.1 Kbytes or less
Data	0.5k bytes
Stack size	400 bytes

RZ/A2M Group 10. Reference Documents

### 10. Reference Documents

User's Manual: Hardware

RZ/A2M Group User's Manual: Hardware (R01UH0746)

(Download the latest version of the manual from the Renesas Electronics website.)

User's Manual: Software

RZ/A2M Group DRP Library User's Manual (R01US0367)

(Download the latest version of the manual from the Renesas Electronics website.)

User's Manual: Development Environment

For the Renesas Electronics integrated development environment (e2 studio), please visit the Renesas

Electronics website to download the latest version.

Technical Update/Technical News

(Download the latest version of the update or news from the Renesas Electronics website.)

## 11. How to Import the Driver

### 11.1 e<sup>2</sup> studio

Please refer to the RZ/A2M Smart Configurator User's Guide: e<sup>2</sup> studio R20AN0583EJ for details on how to import drivers into projects in e<sup>2</sup> studio using the Smart Configurator tool.

## **11.2** For Projects created outside e<sup>2</sup> studio

This section describes how to import the driver into your project.

Generally, there are two steps in any IDE:

- 1) Copy the driver to the location in the source tree that you require for your project.
- 2) Add the link to where you copied your driver to the compiler.

Other required drivers, e.g. r\_cbuffer, must be imported similarly.



# REVISION HISTORY RZ/A2M Group DRP Driver User's Manual

Rev.	Date	Description	
		Page	Summary
1.00	Sep. 14, 2018	ı	First Edition Issued
1.01	May. 31, 2019	29	Added the chapter of "10. How to Import the Driver".
1.02	Jun. 30, 2020	3	2 Operation Conditions, the version of RENESAS e2 studio was changed to 7.8.0.
		25	6.2 State Transitions of Individual Circuits, updated State transition diagram.
1.03	Mar. 31, 2021	1	Changed the DRP interrupt priority level from 8 to 26.
		27	Added the chapter of "8.2 DRP Driver Interrupt Priority".
		28	Added the chapter of "9. Memory footprint".

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